

## TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

16810 U.S. PTO  
10/7/1060

## Title of Invention

HIGH POWER DENSITY INSULATED METAL SUBSTRATE BASED POWER  
CONVERTER ASSEMBLY WITH VERY LOW BUS IMPEDANCE

Application Number:

Date:

First Named Applicant: Mr. Rick West

Confirmation Number:

Attorney Docket Number:

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Submitted by:

Elec. Sign.

Mr. Wil Whalen

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**Documents being submitted**

us-request

us-fee-sheet

us-declaration

application-body

**Files**

IMS-usrequ.xml

us-request.dtd

us-request.xsl

IMS-usfees.xml

us-fee-sheet.xsl

us-fee-sheet.dtd

IMS-usdecl.xml

us-declaration.dtd

us-declaration.xsl

IMSABX.xml

application-body.dtd

wipo.ent

mathml2.dtd

mathml2-qname-1.mod

isoamsa.ent

isoamsb.ent

isoamsc.ent

isoamsn.ent

isoamso.ent

isoamsr.ent

isogr3.ent

isomfrk.ent

isomopf.ent

isomscr.ent

isotech.ent

isobox.ent

isocyr1.ent

isocyr2.ent

isodia.ent

isolat1.ent

isolat2.ent

isonum.ent

isopub.ent

mmlextra.ent

mmlalias.ent

soextblx.dtd

us-application-body.xsl

Image1.tif

Image2.tif

Image3.tif  
Image4.tif  
Image5.tif  
Image6.tif  
Image7.tif

Comments